

## General Purpose Transistors

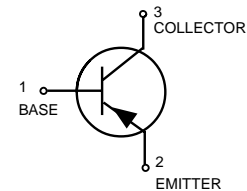
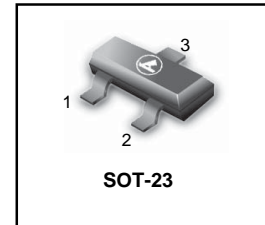
### L2SA812QLT1G Series

#### FEATURE

- High Voltage:  $V_{CEO} = -50$  V.
- Epitaxial planar type.
- NPN complement: L2SC1623
- We declare that the material of product compliance with RoHS requirements.

#### DEVICE MARKING AND ORDERING INFORMATION

Device	Marking	Shipping
L2SA812QLT1G	M8	3000/Tape&Reel
L2SA812QLT3G	M8	10000/Tape&Reel
L2SA812RLT1G	M6	3000/Tape&Reel
L2SA812RLT3G	M6	10000/Tape&Reel
L2SA812SLT1G	M7	3000/Tape&Reel
L2SA812SLT3G	M7	10000/Tape&Reel



#### MAXIMUM RATINGS

Rating	Symbol	L2SA812	Unit
Collector-Emitter Voltage	$V_{CEO}$	-50	V
Collector-Base Voltage	$V_{CBO}$	-60	V
Emitter-Base Voltage	$V_{EBO}$	-6	V
Collector current-continuoun	$I_c$	-150	mAdc

#### THERMAL CHARATEERISTICS

Characteristic	Symbol	Max	Unit
Total Device Dissipation FR-5 Board, (1) $T_A=25^\circ\text{C}$ Derate above $25^\circ\text{C}$	$P_D$	200 1.8	mW mW/ $^\circ\text{C}$
Thermal Resistance, Junction to Ambient	$R_{\theta JA}$	556	$^\circ\text{C}/\text{W}$
Total Device Dissipation Alumina Substrate, (2) $T_A=25^\circ\text{C}$ Derate above $25^\circ\text{C}$	$P_D$	200 2.4	mW mW/ $^\circ\text{C}$
Thermal Resistance, Junction to Ambient	$R_{\theta JA}$	417	$^\circ\text{C}/\text{W}$
Junction and Storage Temperature	$T_j, T_{stg}$	-55 to +150	$^\circ\text{C}$

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### ELECTRICAL CHARACTERISTICS (TA=25°C unless otherwise noted)

Characteristic	Symbol	Min	Typ	Max	Unit
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#### OFF CHARACTERISTICS

Collector-Emitter Breakdown Voltage ( $I_C = -1\text{mA}$ )	$V_{(BR)CEO}$	-50	-	-	V
Emitter-Base Breakdown Voltage ( $I_E = -50\ \mu\text{A}$ )	$V_{(BR)EBO}$	-6	-	-	V
Collector-Base Breakdown Voltage ( $I_C = -50\ \mu\text{A}$ )	$V_{(BR)CBO}$	-60	-	-	V
Collector Cutoff Current ( $V_{CB} = -50\text{V}$ )	$I_{CBO}$	-	-	-0.1	$\mu\text{A}$
Emitter Cutoff Current ( $V_{BE} = -6\text{V}$ )	$I_{EBO}$	-	-	-0.1	$\mu\text{A}$

#### ON CHARACTERISTICS

DC Current Gain ( $I_C = -1\text{mA}, V_{CE} = -6.0\text{V}$ )	$h_{FE}$	120	-	560	
Collector-Emitter Saturation Voltage ( $I_C = -100\text{mA}, I_B = -10\text{mA}$ )	$V_{CE(sat)}$	-	-0.18	-0.3	V
Base -Emitter On Voltage ( $I_E = -1.0\text{mA}, V_{CE} = -6.0\text{V}$ )	$V_{BE}$	-0.58	-0.62	-0.68	V

#### SMALL-SIGNAL CHARACTERISTICS

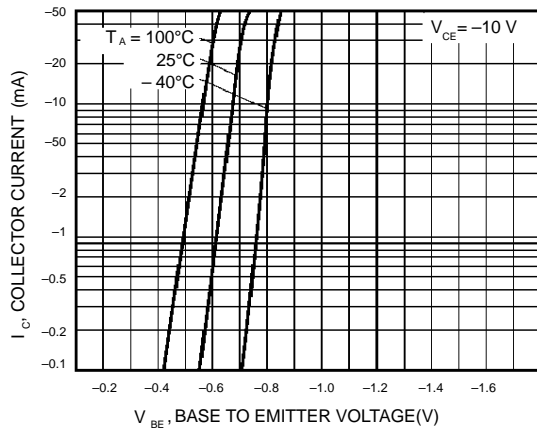
Current-Gain-Bandwidth Product ( $V_{CE} = -6.0\text{V}, I_E = -10\text{mA}$ )	$F_t$	-	180	-	MHz
Output Capacitance ( $V_{CE} = -10\text{V}, I_E = 0, f = 1.0\text{MHz}$ )	$C_{obo}$	-	4.5	-	pF

$h_{FE}$  Values are classified as follows

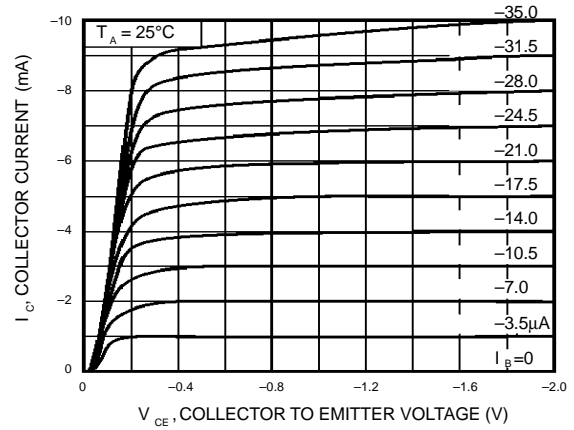
NOTE:	*	Q	R	S
$h_{FE}$		120~270	180~390	270~560

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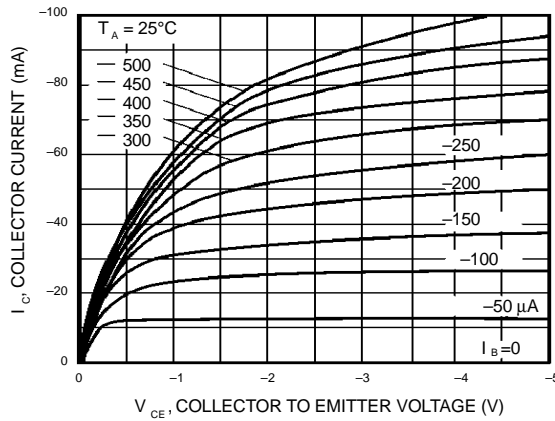
**Fig.1** Grounded emitter propagation characteristics



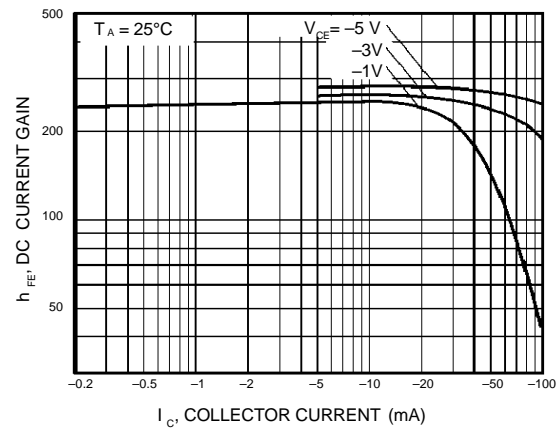
**Fig.2** Grounded emitter output characteristics(I)



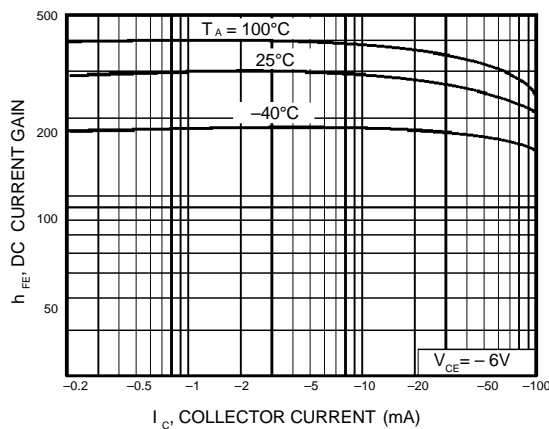
**Fig.3** Grounded emitter output characteristics(II)



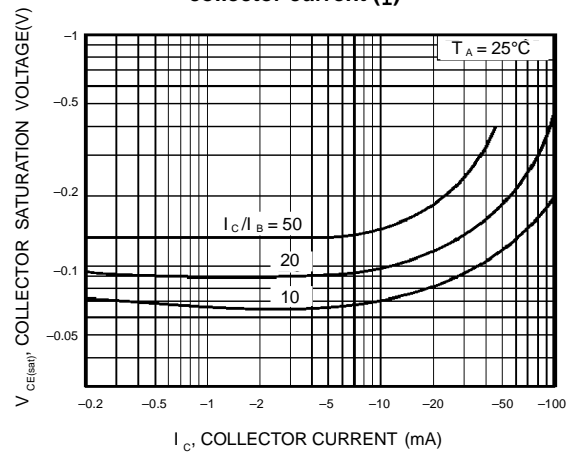
**Fig.4** DC current gain vs. collector current (I)



**Fig.5** DC current gain vs. collector current (II)

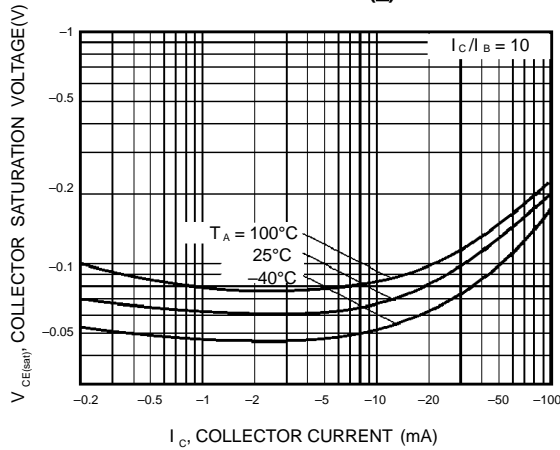


**Fig.6** Collector-emitter saturation voltage vs. collector current (I)

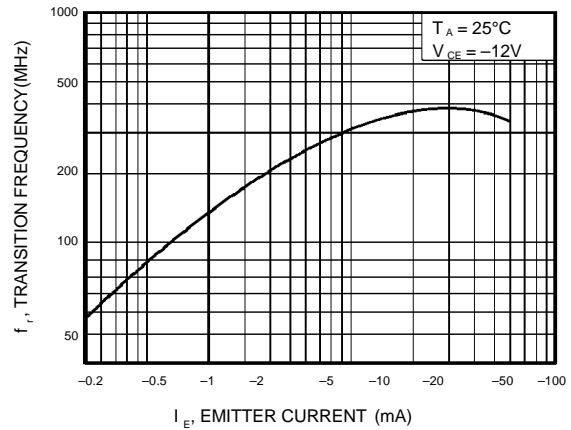


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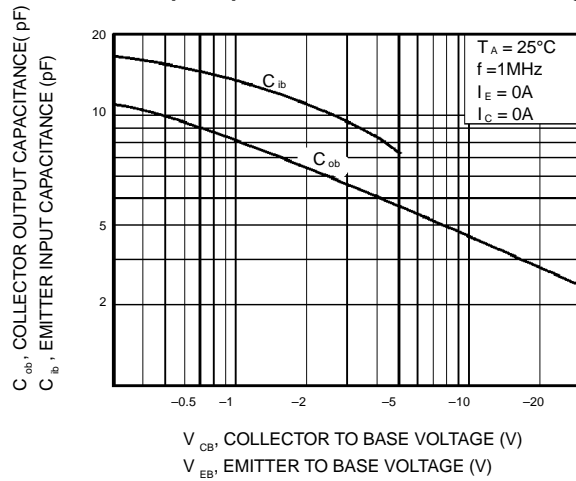
**Fig.7 Collector-emitter saturation voltage vs. collector current (I)**



**Fig.8 Gain bandwidth product vs. emitter current**



**Fig.9 Collector output capacitance vs. collector-base voltage  
Emitter input capacitance vs. emitter-base voltage**

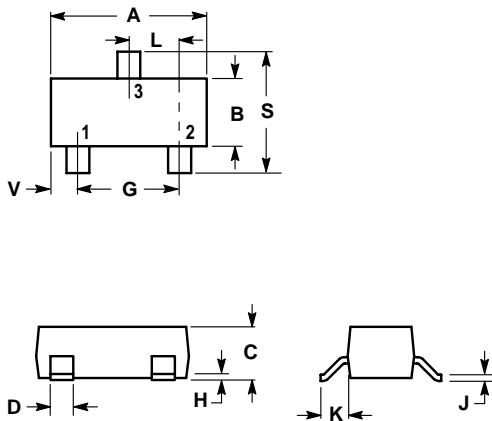


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### SOT-23

NOTES:

1. DIMENSIONING AND TOLERANCING PER ANSI Y14.5M,1982
2. CONTROLLING DIMENSION: INCH.



DIM	INCHES		MILLIMETERS	
	MIN	MAX	MIN	MAX
A	0.1102	0.1197	2.80	3.04
B	0.0472	0.0551	1.20	1.40
C	0.0350	0.0440	0.89	1.11
D	0.0150	0.0200	0.37	0.50
G	0.0701	0.0807	1.78	2.04
H	0.0005	0.0040	0.013	0.100
J	0.0034	0.0070	0.085	0.177
K	0.0140	0.0285	0.35	0.69
L	0.0350	0.0401	0.89	1.02
S	0.0830	0.1039	2.10	2.64
V	0.0177	0.0236	0.45	0.60

